

$V_{DSS}$	500V
$R_{DS(on)}$ (Max.)	0.72Ω
$I_D$	9A
$P_D$	50W

### ●Features

- 1) Low on-resistance.
- 2) Fast switching speed.
- 3) Gate-source voltage ( $V_{GSS}$ ) guaranteed to be ±30V.
- 4) Drive circuits can be simple.
- 5) Parallel use is easy.
- 6) Pb-free lead plating ; RoHS compliant

### ●Application

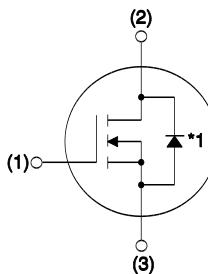
Switching Power Supply

### ●Outline

TO-220FM



### ●Inner circuit



(1) Gate  
(2) Drain  
(3) Source  
\*1 Body Diode

### ●Packaging specifications

Type	Packaging	Bulk
	Reel size (mm)	-
	Tape width (mm)	-
	Basic ordering unit (pcs)	500
	Taping code	-
	Marking	R5009ANX

### ●Absolute maximum ratings( $T_a = 25^\circ\text{C}$ )

Parameter	Symbol	Value	Unit
Drain - Source voltage	$V_{DSS}$	500	V
Continuous drain current	$I_D$ *1 $T_c = 25^\circ\text{C}$	±9	A
	$I_D$ *1 $T_c = 100^\circ\text{C}$	±4.3	A
Pulsed drain current	$I_{D,pulse}$ *2	±36	A
Gate - Source voltage	$V_{GSS}$	±30	V
Avalanche energy, single pulse	$E_{AS}$ *3	5.4	mJ
Avalanche energy, repetitive	$E_{AR}$ *4	3.5	mJ
Avalanche current	$I_{AR}$ *3	4.5	A
Power dissipation ( $T_c = 25^\circ\text{C}$ )	$P_D$	50	W
Junction temperature	$T_j$	150	°C
Range of storage temperature	$T_{stg}$	-55 to +150	°C
Reverse diode dv/dt	dv/dt *5	15	V/ns

**●Absolute maximum ratings**

Parameter	Symbol	Conditions	Values	Unit
Drain - Source voltage slope	dv/dt	$V_{DS} = 400V$ , $I_D = 9A$ $T_j = 125^\circ C$	50	V/ns

**●Thermal resistance**

Parameter	Symbol	Values			Unit
		Min.	Typ.	Max.	
Thermal resistance, junction - case	$R_{thJC}$	-	-	2.5	°C/W
Thermal resistance, junction - ambient	$R_{thJA}$	-	-	70	°C/W
Soldering temperature, wavesoldering for 10s	$T_{sold}$	-	-	265	°C

**●Electrical characteristics( $T_a = 25^\circ C$ )**

Parameter	Symbol	Conditions	Values			Unit
			Min.	Typ.	Max.	
Drain - Source breakdown voltage	$V_{(BR)DSS}$	$V_{GS} = 0V$ , $I_D = 1mA$	500	-	-	V
Drain - Source avalanche breakdown voltage	$V_{(BR)DS}$	$V_{GS} = 0V$ , $I_D = 9A$	-	580	-	V
Zero gate voltage drain current	$I_{DSS}$	$V_{DS} = 500V$ , $V_{GS} = 0V$ $T_j = 25^\circ C$ $T_j = 125^\circ C$	-	0.1	100	$\mu A$
Gate - Source leakage current	$I_{GSS}$	$V_{GS} = \pm 30V$ , $V_{DS} = 0V$	-	-	$\pm 100$	nA
Gate threshold voltage	$V_{GS(th)}$	$V_{DS} = 10V$ , $I_D = 1mA$	2.5	-	4.5	V
Static drain - source on - state resistance	$R_{DS(on)}^{*6}$	$V_{GS} = 10V$ , $I_D = 4.5A$ $T_j = 25^\circ C$ $T_j = 125^\circ C$	-	0.55	0.72	$\Omega$
Gate input resistance	$R_G$	f = 1MHz, open drain	-	8.3	-	$\Omega$

● Electrical characteristics( $T_a = 25^\circ\text{C}$ )

Parameter	Symbol	Conditions	Values			Unit
			Min.	Typ.	Max.	
Transconductance	$g_{fs}^{*6}$	$V_{DS} = 10\text{V}, I_D = 4.5\text{A}$	2.5	6	-	S
Input capacitance	$C_{iss}$	$V_{GS} = 0\text{V}$ $V_{DS} = 25\text{V}$ $f = 1\text{MHz}$	-	650	-	pF
Output capacitance	$C_{oss}$		-	400	-	
Reverse transfer capacitance	$C_{rss}$		-	30	-	
Effective output capacitance, energy related	$C_{o(er)}$	$V_{GS} = 0\text{V}$ $V_{DS} = 0\text{V to } 400\text{V}$	-	45.8	-	pF
Effective output capacitance, time related	$C_{o(tr)}$		-	48.2	-	
Turn - on delay time	$t_{d(on)}^{*6}$	$V_{DD} \approx 250\text{V}, V_{GS} = 10\text{V}$ $I_D = 4.5\text{A}$ $R_L = 55.6\Omega$ $R_G = 10\Omega$	-	30	-	ns
Rise time	$t_r^{*6}$		-	20	-	
Turn - off delay time	$t_{d(off)}^{*6}$		-	62	124	
Fall time	$t_f^{*6}$		-	28	56	

● Gate Charge characteristics( $T_a = 25^\circ\text{C}$ )

Parameter	Symbol	Conditions	Values			Unit
			Min.	Typ.	Max.	
Total gate charge	$Q_g^{*6}$	$V_{DD} \approx 250\text{V}$	-	21	-	nC
Gate - Source charge	$Q_{gs}^{*6}$	$I_D = 9\text{A}$	-	5	-	
Gate - Drain charge	$Q_{gd}^{*6}$		-	9	-	
Gate plateau voltage	$V_{(plateau)}$	$V_{DD} \approx 250\text{V}, I_D = 9\text{A}$	-	6.0	-	V

\*1 Limited only by maximum temperature allowed.

\*2  $P_w \leq 10\mu\text{s}$ , Duty cycle  $\leq 1\%$

\*3  $L \approx 500\mu\text{H}$ ,  $V_{DD} = 50\text{V}$ ,  $R_G = 25\Omega$ , starting  $T_j = 25^\circ\text{C}$

\*4  $L \approx 500\mu\text{H}$ ,  $V_{DD} = 50\text{V}$ ,  $R_G = 25\Omega$ , starting  $T_j = 25^\circ\text{C}$ ,  $f = 10\text{kHz}$

\*5 Reference measurement circuits Fig.5-1.

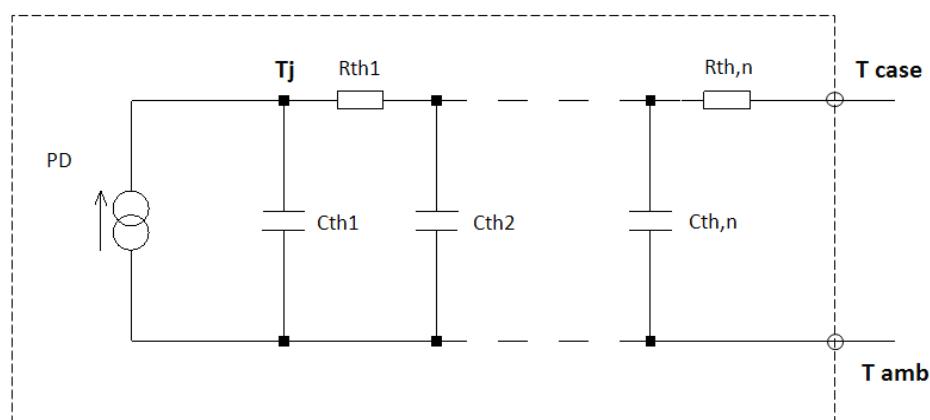
\*6 Pulsed

● Body diode electrical characteristics (Source-Drain)( $T_a = 25^\circ\text{C}$ )

Parameter	Symbol	Conditions	Values			Unit
			Min.	Typ.	Max.	
Inverse diode continuous, forward current	$I_S^{*1}$	$T_c = 25^\circ\text{C}$	-	-	9	A
Inverse diode direct current, pulsed	$I_{SM}^{*2}$		-	-	36	A
Forward voltage	$V_{SD}^{*6}$	$V_{GS} = 0\text{V}, I_S = 9\text{A}$	-	-	1.5	V
Reverse recovery time	$t_{rr}^{*6}$	$I_S = 9\text{A}$ $dI/dt = 100\text{A/us}$	-	376	-	ns
Reverse recovery charge	$Q_{rr}^{*6}$		-	3.0	-	$\mu\text{C}$
Peak reverse recovery current	$I_{rrm}^{*6}$		-	16	-	A
Peak rate of fall of reverse recovery current	$di_{rr}/dt$	$T_j = 25^\circ\text{C}$	-	400	-	$\text{A}/\mu\text{s}$

● Typical Transient Thermal Characteristics

Symbol	Value	Unit	Symbol	Value	Unit
$R_{th1}$	0.263	K/W	$C_{th1}$	0.00166	Ws/K
$R_{th2}$	0.977		$C_{th2}$	0.0191	
$R_{th3}$	2.18		$C_{th3}$	0.46	



## ● Electrical characteristic curves

Fig.1 Power Dissipation Derating Curve

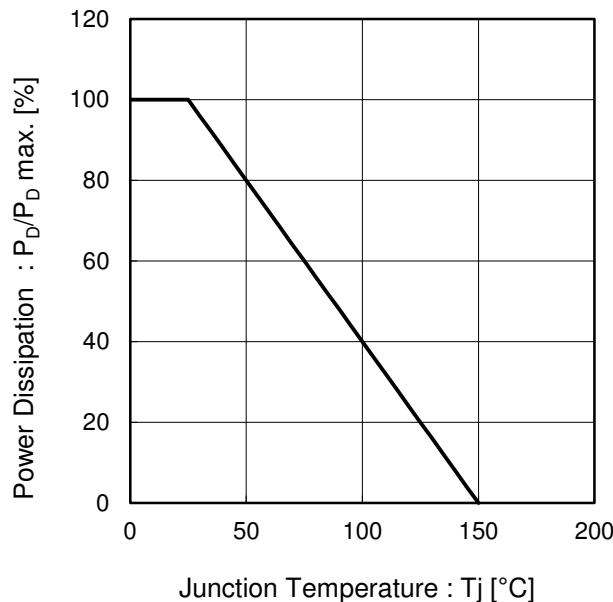


Fig.2 Maximum Safe Operating Area

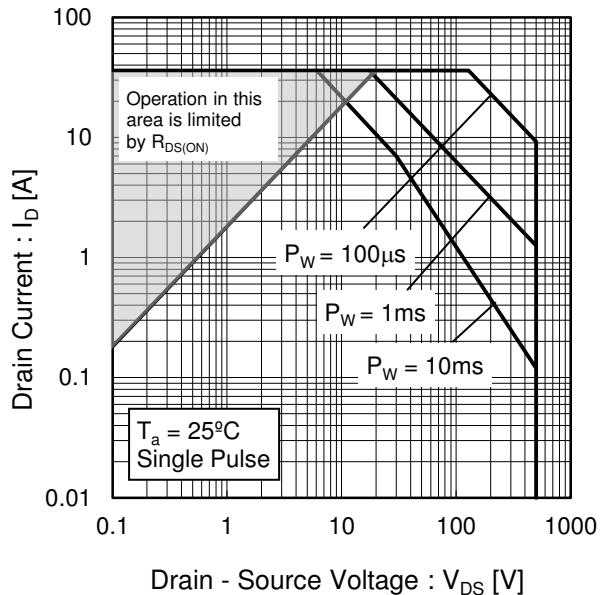
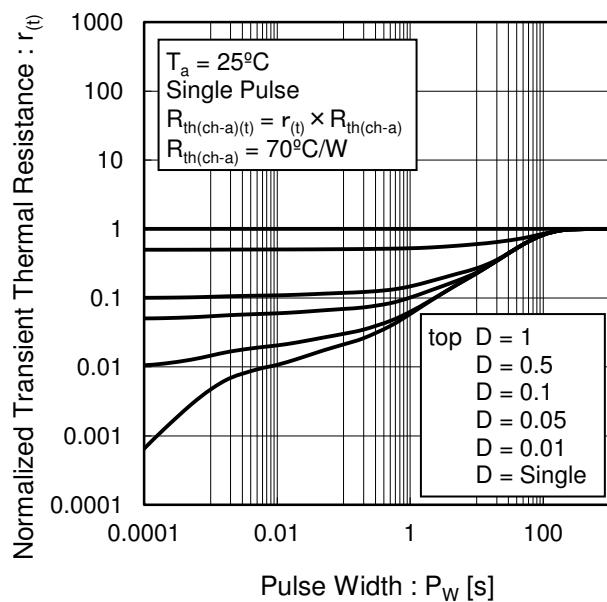


Fig.3 Normalized Transient Thermal Resistance vs. Pulse Width



●Electrical characteristic curves

Fig.4 Avalanche Current vs Inductive Load

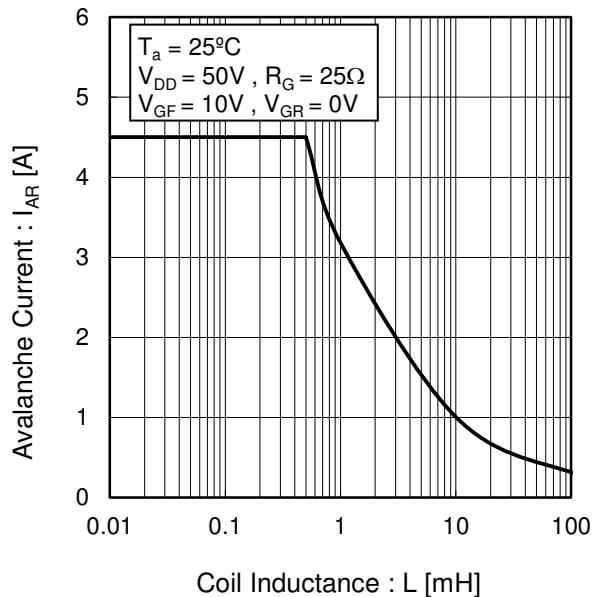


Fig.5 Avalanche Power Losses

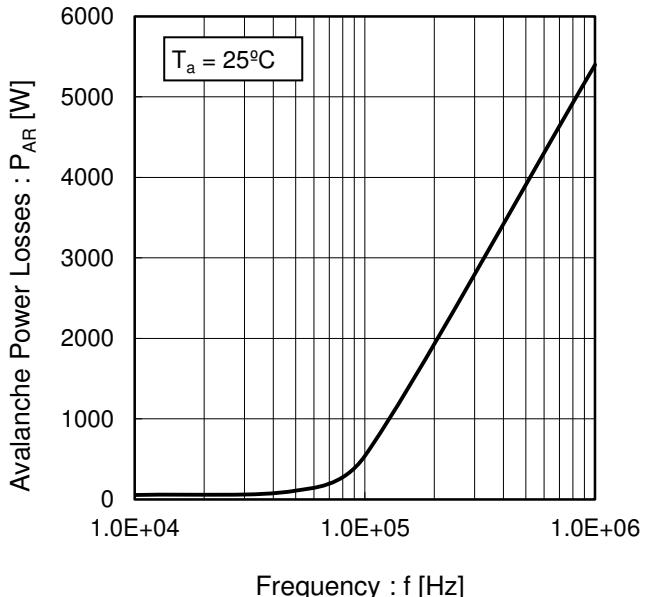
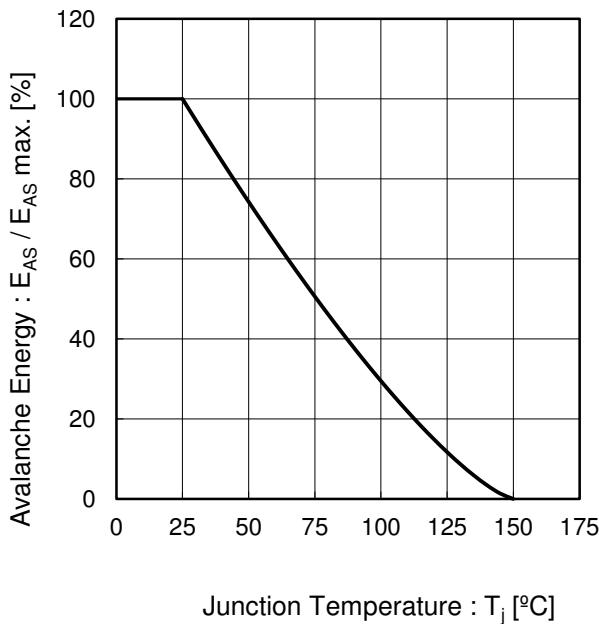


Fig.6 Avalanche Energy Derating Curve  
vs Junction Temperature



●Electrical characteristic curves

Fig.7 Typical Output Characteristics(I)

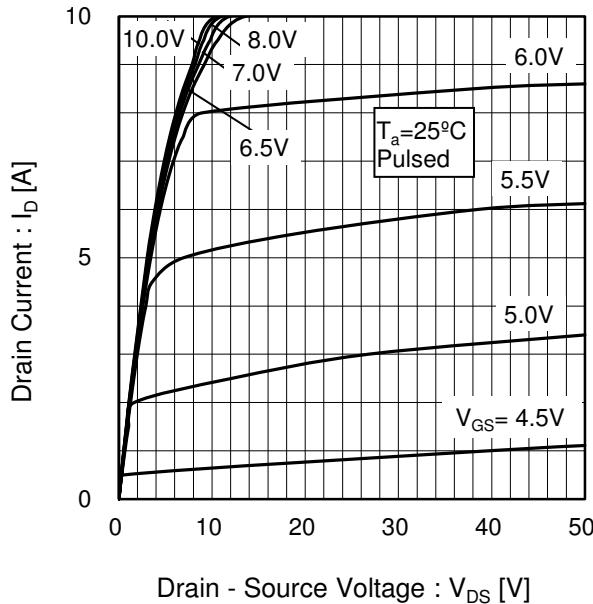


Fig.8 Typical Output Characteristics(II)

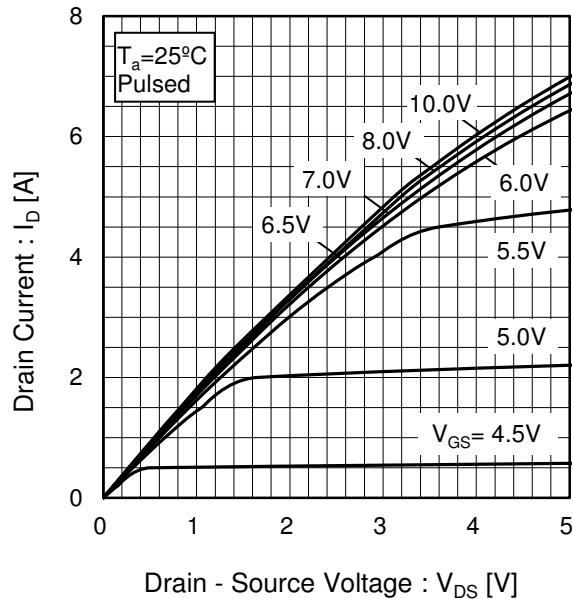


Fig.9  $T_j = 150^\circ\text{C}$  Typical Output Characteristics(I)

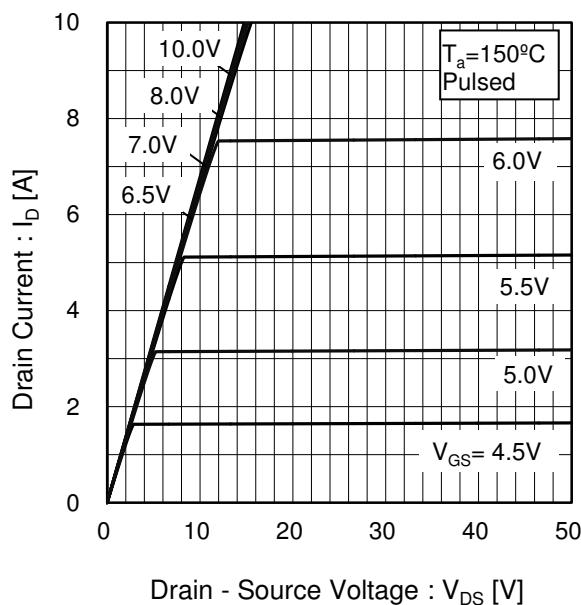
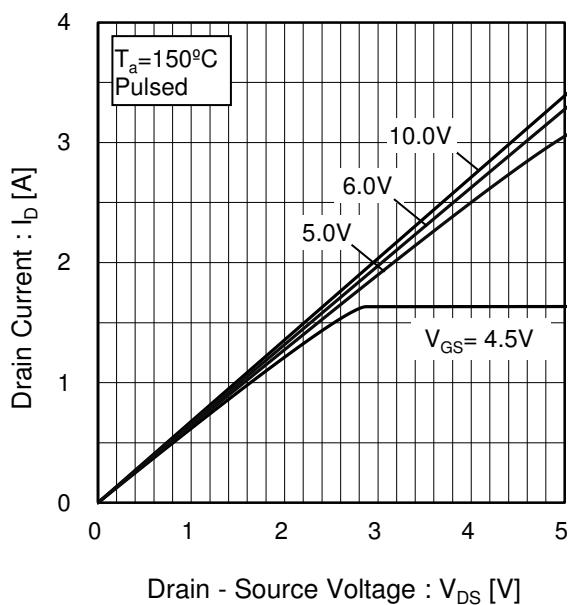


Fig.10  $T_j = 150^\circ\text{C}$  Typical Output Characteristics(II)



●Electrical characteristic curves

Fig.11 Breakdown Voltage  
vs. Junction Temperature

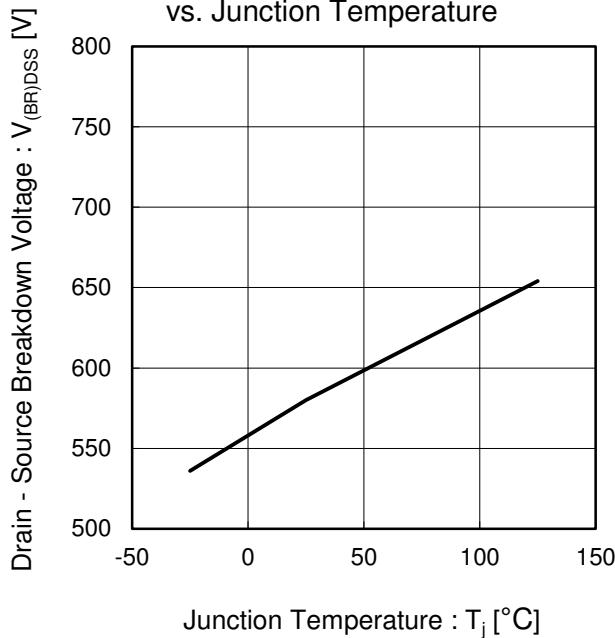


Fig.12 Typical Transfer Characteristics

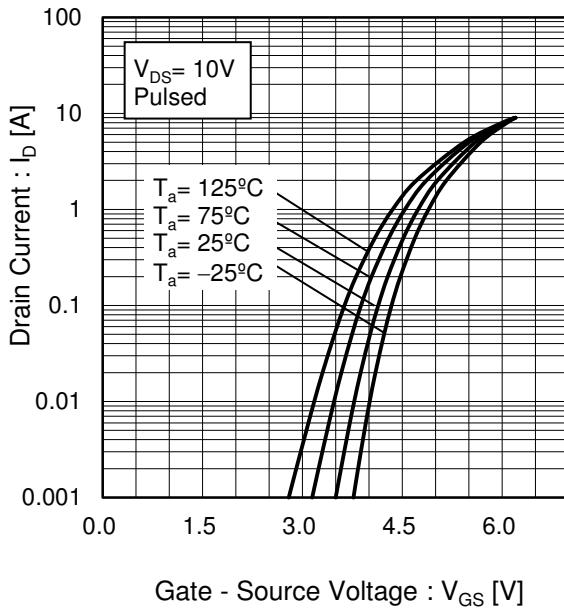


Fig.13 Gate Threshold Voltage  
vs. Junction Temperature

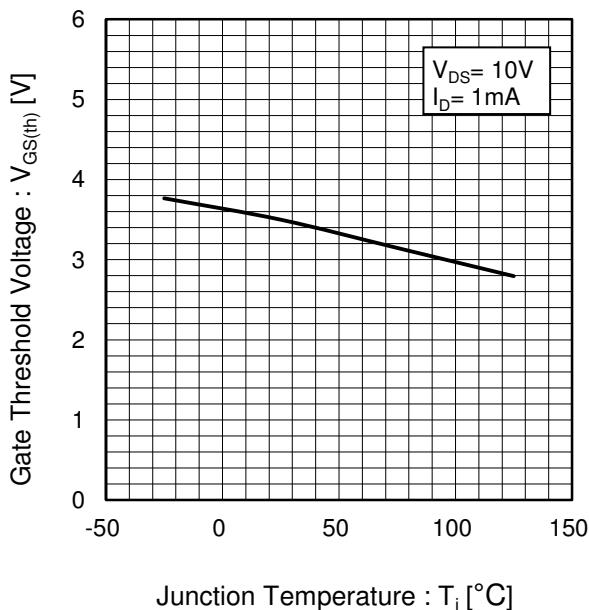
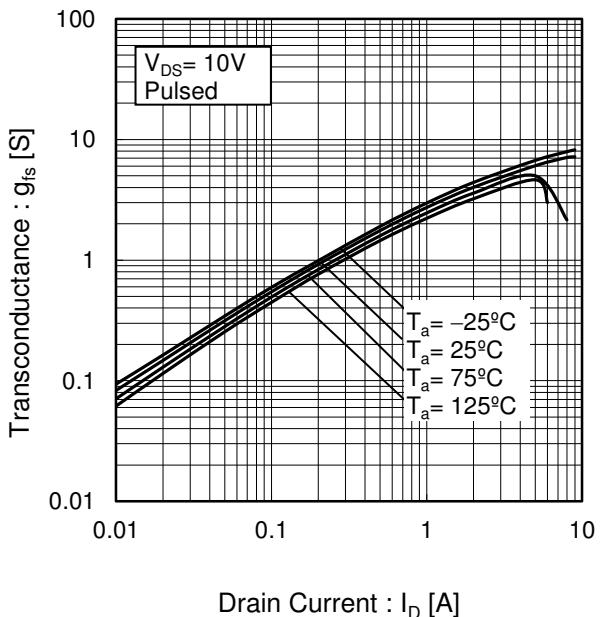


Fig.14 Transconductance vs. Drain Current



### ●Electrical characteristic curves

Fig.15 Static Drain - Source On - State Resistance vs. Gate Source Voltage

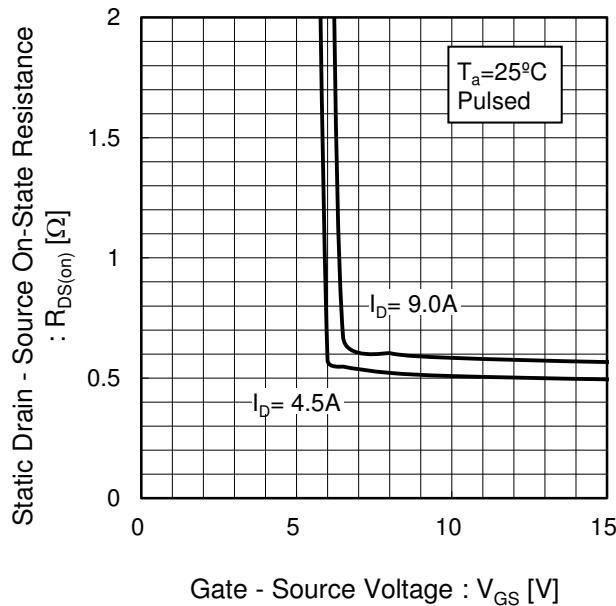


Fig.16 Static Drain - Source On - State Resistance vs. Junction Temperature

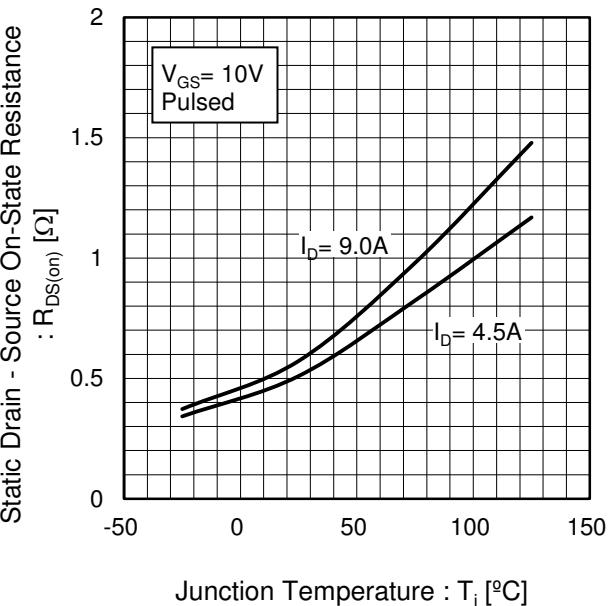
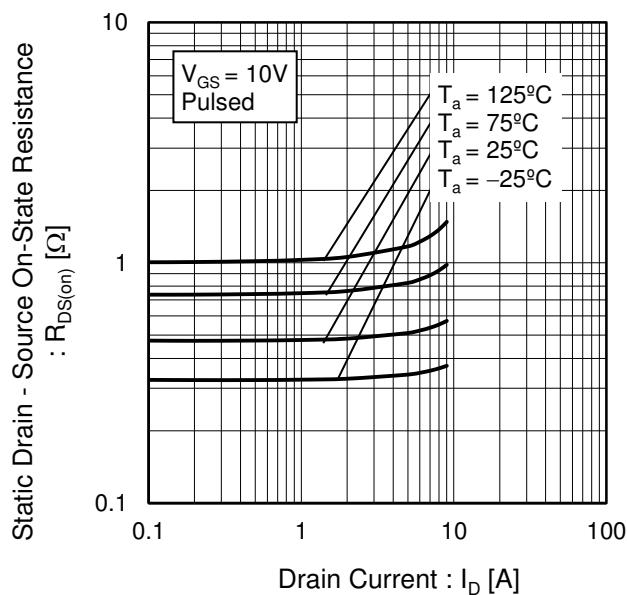


Fig.17 Static Drain - Source On - State Resistance vs. Drain Current



### ●Electrical characteristic curves

Fig.18 Typical Capacitance vs. Drain - Source Voltage

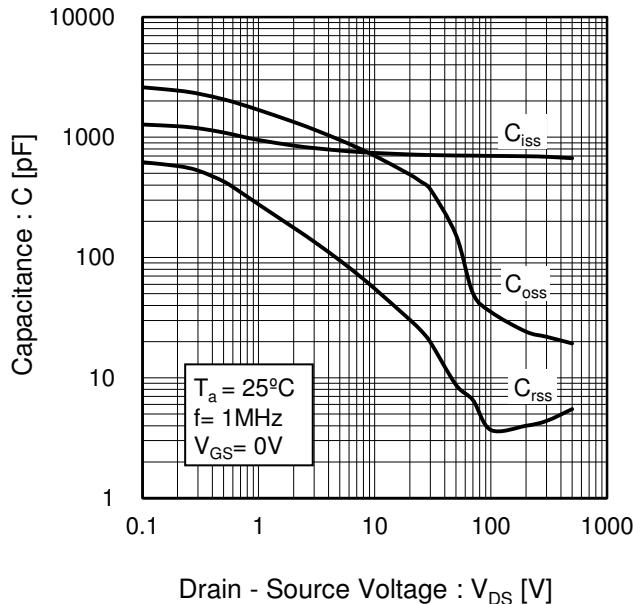


Fig.19 Coss Stored Energy

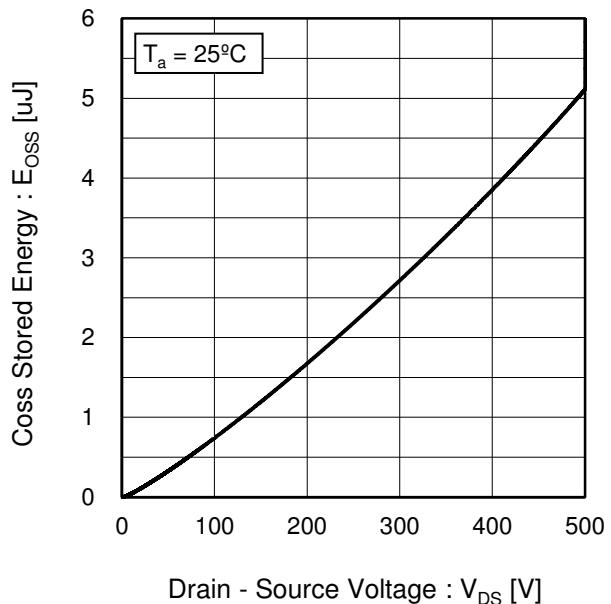


Fig.20 Switching Characteristics

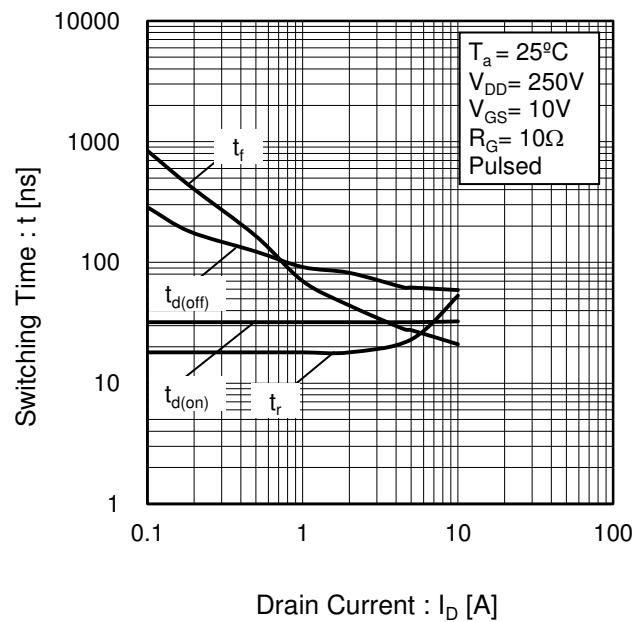
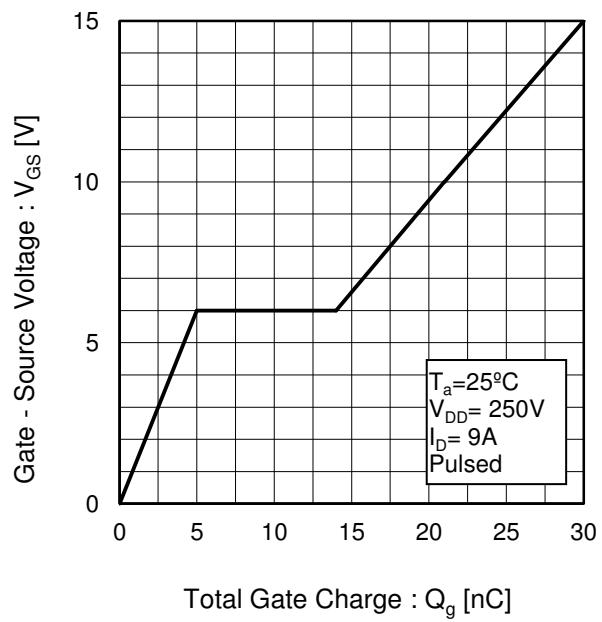


Fig.21 Dynamic Input Characteristics



●Electrical characteristic curves

Fig.22 Inverse Diode Forward Current vs. Source - Drain Voltage

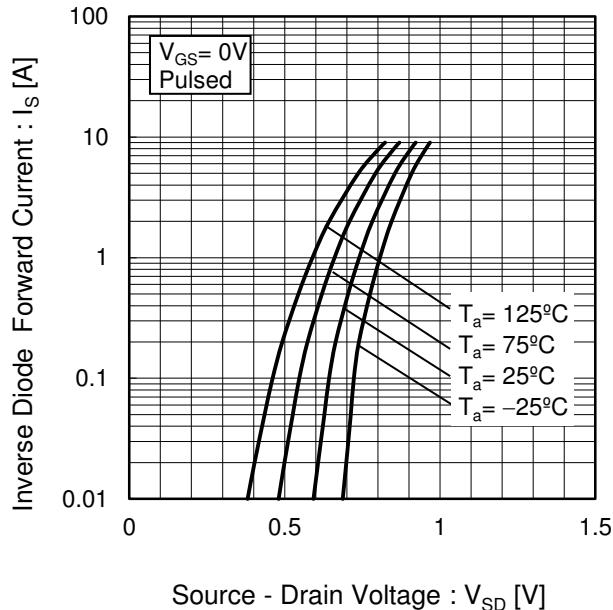
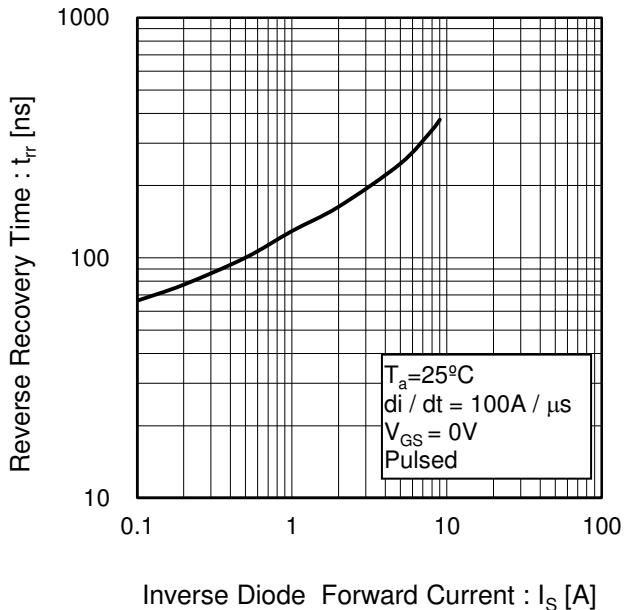


Fig.23 Reverse Recovery Time vs. Inverse Diode Forward Current



## ● Measurement circuits

Fig.1-1 Switching Time Measurement Circuit

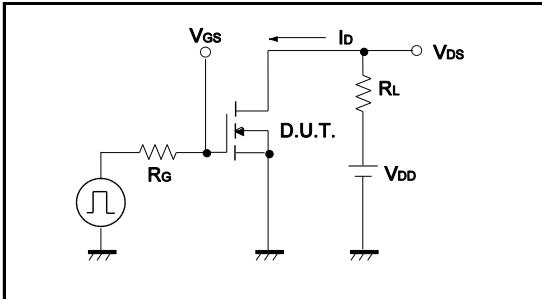


Fig.1-2 Switching Waveforms

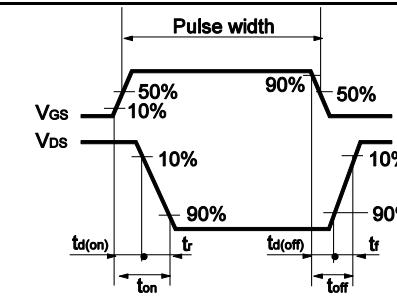


Fig.2-1 Gate Charge Measurement Circuit

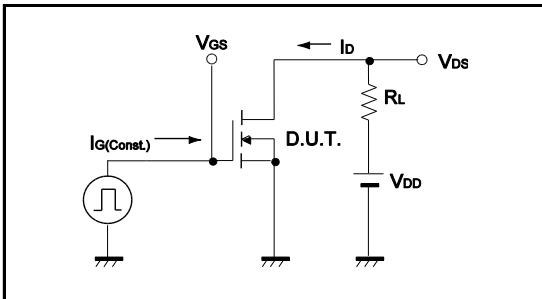


Fig.2-2 Gate Charge Waveform

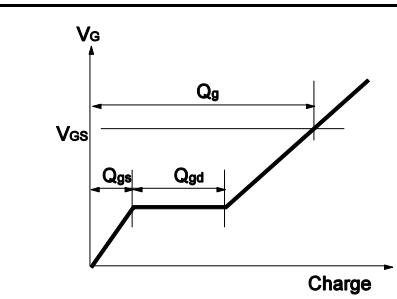


Fig.3-1 Avalanche Measurement Circuit

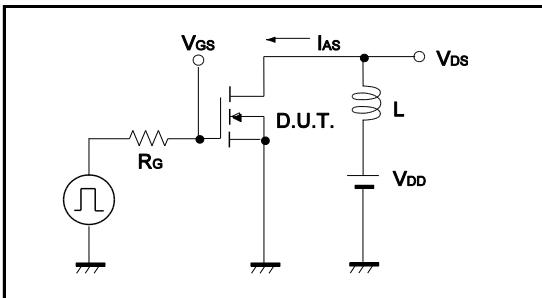


Fig.3-2 Avalanche Waveform

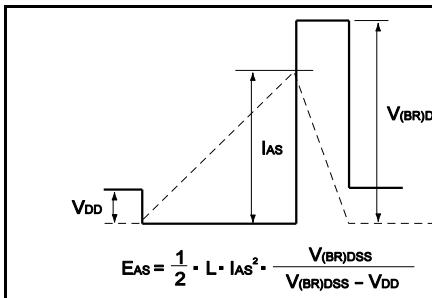


Fig.4-1 dv/dt Measurement Circuit

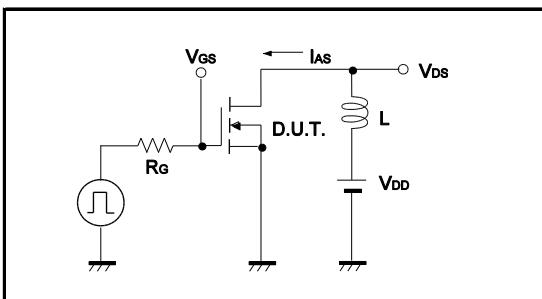


Fig.4-2 dv/dt Waveform

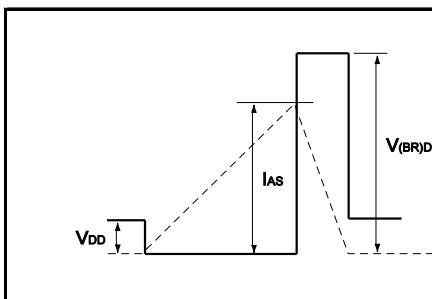


Fig.5-1 di/dt Measurement Circuit

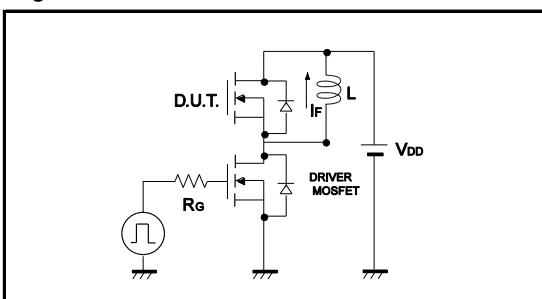
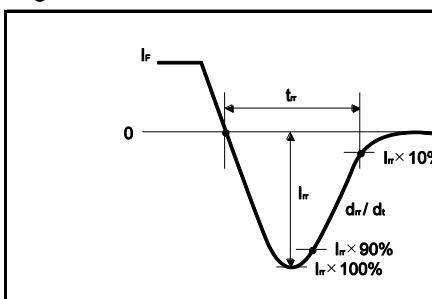
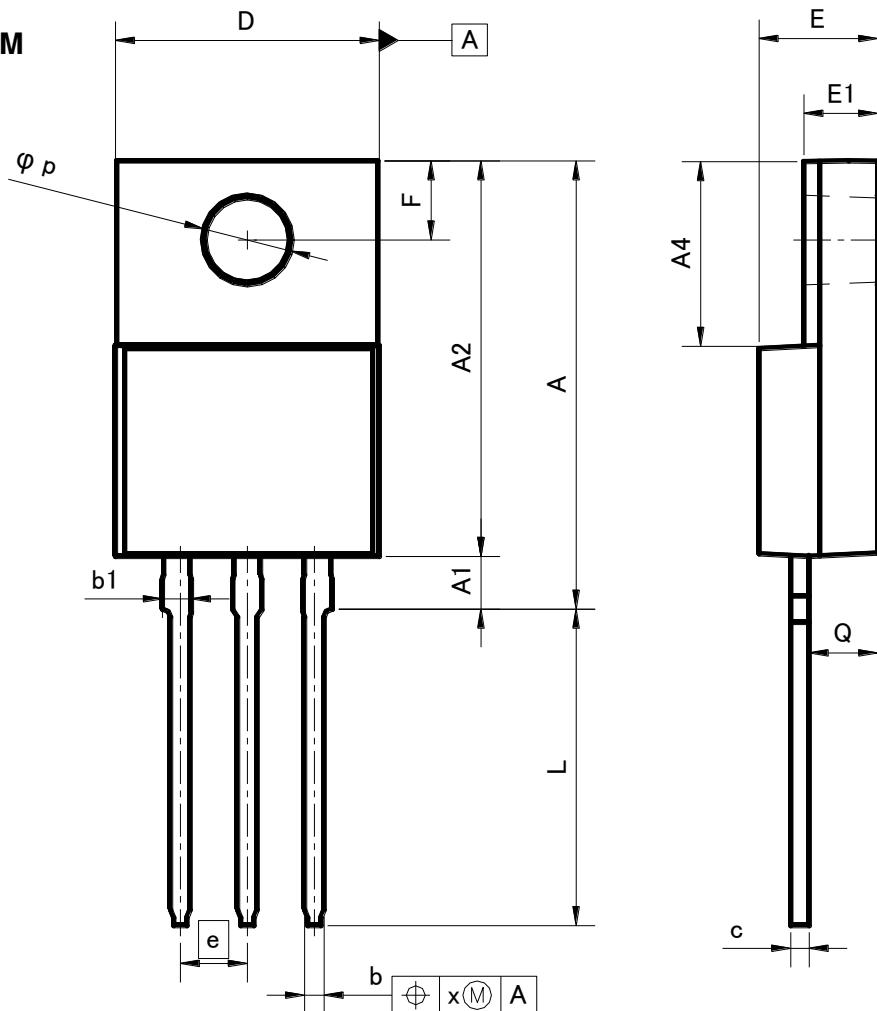


Fig.5-2 di/dt Waveform



●Dimensions (Unit : mm)

TO-220FM



DIM	MILLIMETERS		INCHES	
	MIN	MAX	MIN	MAX
A	16.60	17.60	0.654	0.693
A1	1.80	2.20	0.071	0.087
A2	14.80	15.40	0.583	0.606
A4	6.80	7.20	0.268	0.283
b	0.70	0.85	0.028	0.033
b1	1.10	1.50	0.043	0.059
c	0.70	0.85	0.028	0.033
D	9.90	10.30	0.39	0.406
E	4.40	4.80	0.173	0.189
e	2.54		0.10	
E1	2.70	3.00	0.106	0.118
F	2.80	3.20	0.11	0.126
L	11.50	12.50	0.453	0.492
p	3.00	3.40	0.118	0.134
Q	2.10	3.10	0.083	0.122
x	-	0.381	-	0.015

Dimension in mm/inches

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